Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

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CUI INC®

MODEL: PJ-035-SMT-TR | DESCRIPTION: DC POWER JACK

FEATURES

- 1.0mm center pin
- 2.0 A rating
- right angle orientation
- surface mount (SMT)
- shielded
- 3 conductor

RoHS

SPECIFICATIONS

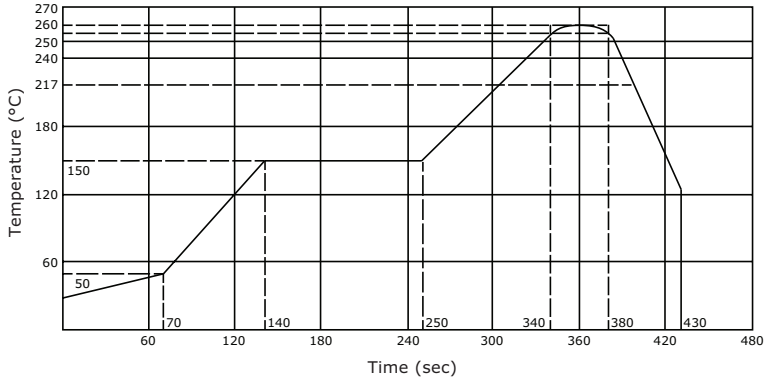
parameter	conditions/description	min	typ	max	units
rated input voltage			24		Vdc
rated input current				2.0	A
contact resistance[1]	between terminal and mating plug between terminal in a closed circuit			50 30	mΩ mΩ
insulation resistance	at 500 Vdc	100			MΩ
voltage withstand	for 1 minute			500	Vac
insertion/withdrawal force		0.3		3	kg
operating temperature		-25		85	°C
life	at a rate of 24 cycles/minute		5,000		cycles
flammability rating	UL94V-0				
RoHS	2011/65/EU				

Note: 1. When measured at a current of less than 100 mA/1 kHz
2. All specifications measured at 10~35°C, humidity at 45~85%, under standard atmospheric pressure, unless otherwise noted.

SOLDERABILITY

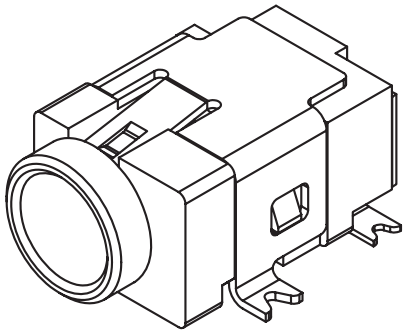
parameter	conditions/description	min	typ	max	units
reel storage	at relative humidity <80%			40	°C
reflow soldering[3]	see reflow profile	255	260	265	°C
drying conditions[4]	parts in reel: bake at 40°C ±5°C for 72 hours parts removed from reel: bake at 40°C ±5°C for 10 hours				

Note: 3. Must reflow solder within 72 hours from opening vacuum packaging at a temperature <30°C & relative humidity <60%.
4. When exceeding floor life by >72 hours.

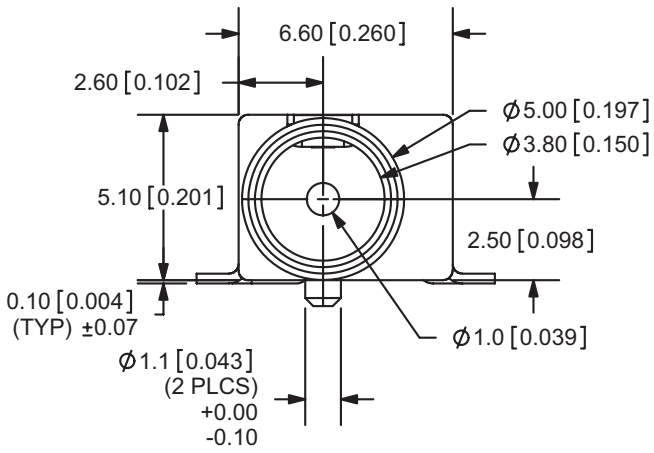


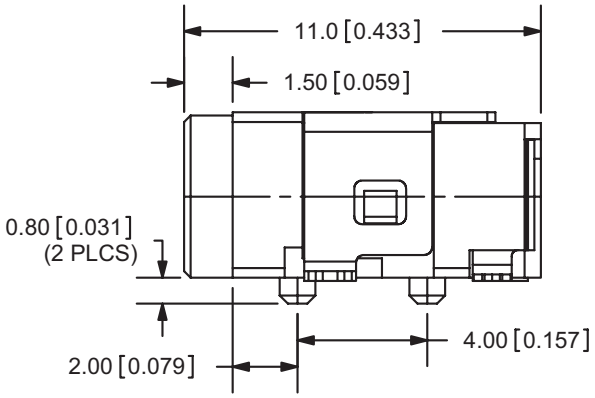
MECHANICAL DRAWING

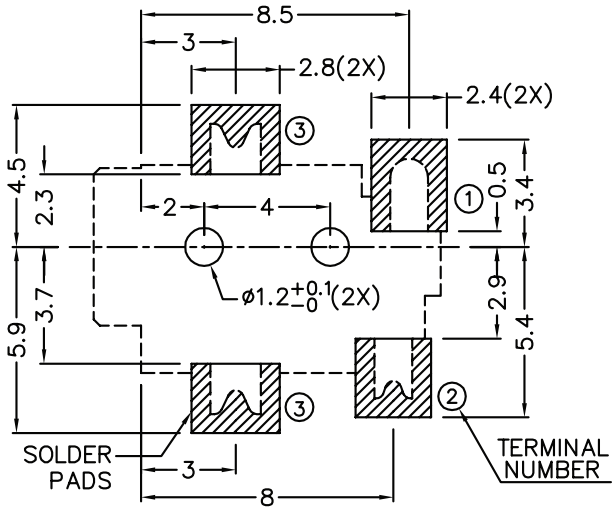
units: mm[inches]
tolerance:
X.X ±0.2mm
X.XX ±0.1mm
X.XXX ±0.05mm
PCB: ±0.05 mm



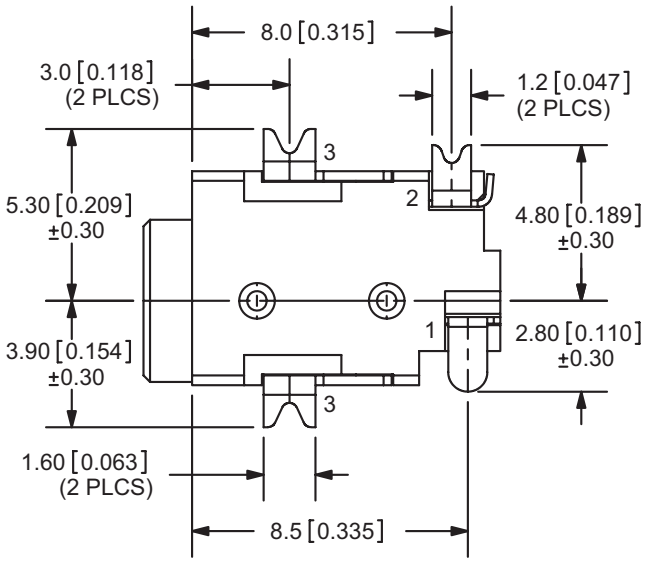
	MATERIAL	PLATING
center pin	brass	silver
terminal 1	brass	silver
terminal 2	copper alloy	silver
terminal 3	copper alloy	silver
plastic	PA6T or equivalent	

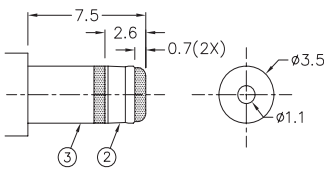




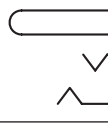


Recommended PCB Layout
Top View





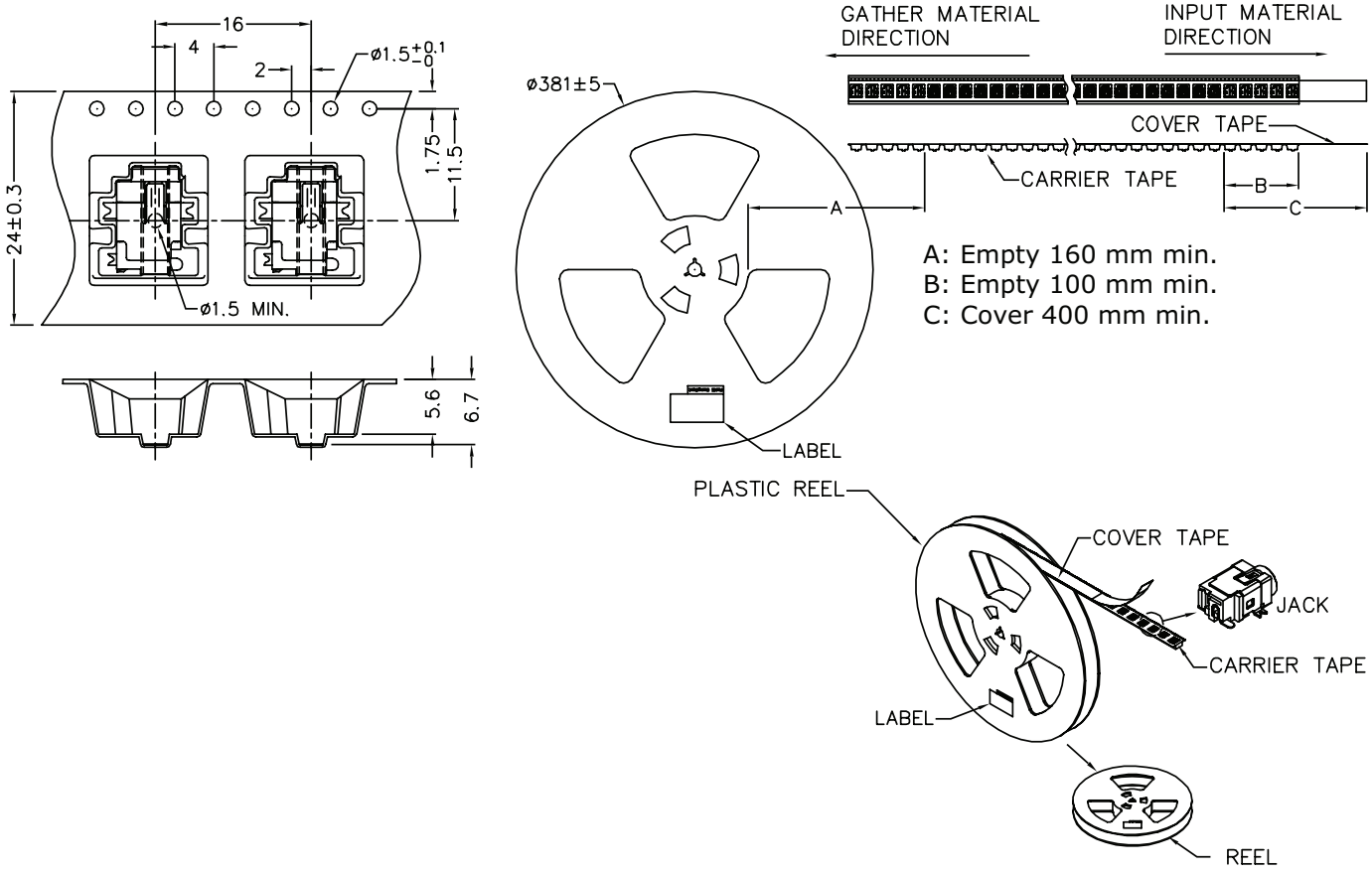
MATING PLUG
Jack Insertion Depth: 7.3mm

SCHEMATIC	
Model	PJ-035-SMT
Center Pin	Ø1.0 mm

PACKAGING

units: mm

Reel Size: Ø381 mm
Reel QTY: 850 pcs per reel



REVISION HISTORY

rev.	description	date
1.0	initial release	02/02/2007
1.01	updated schematic	09/27/2007
1.02	added TR package option and jack insertion depth	11/07/2012
1.03	applied new spec template	08/30/2013
1.04	increased voltage rating	04/14/2016
1.05	added storage and drying conditions, and tape and reel packaging details	08/18/2017

The revision history provided is for informational purposes only and is believed to be accurate.

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